

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0240F uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

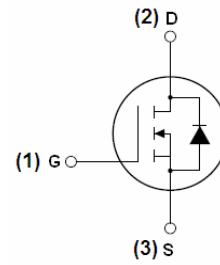
- $V_{DS} = 200V, I_D = 40A$
 $R_{DS(ON)} < 41m\Omega @ V_{GS} = 10V$
- High density cell design for ultra low R_{dson}
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔV_{ds} TESTED!



Schematic diagram



Marking and pin assignment



TO-220F top view

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| NCE0240F | NCE0240F | TO-220F | - | - | - |

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|---|--------------------|------------|---------------|
| Drain-Source Voltage | V_{DS} | 200 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous | I_D | 40 | A |
| Drain Current-Continuous($T_C = 100^\circ C$) | $I_D(100^\circ C)$ | 28 | A |
| Pulsed Drain Current | I_{DM} | 160 | A |
| Maximum Power Dissipation | P_D | 60 | W |
| Derating factor | | 0.4 | W/ $^\circ C$ |
| Single pulse avalanche energy ^(Note 5) | E_{AS} | 480 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 175 | $^\circ C$ |

Thermal Characteristic

| | | | |
|---|-----------------|-----|------|
| Thermal Resistance, Junction-to-Ambient ^(Note 2) | $R_{\theta JA}$ | 2.5 | °C/W |
|---|-----------------|-----|------|

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|--------------|---|-----|------|-----------|------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 200 | 220 | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=200V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 2 | 3.2 | 4 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=20A$ | - | 36.4 | 41 | m Ω |
| Forward Transconductance | g_{FS} | $V_{DS}=25V, I_D=25A$ | 26 | - | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=25V, V_{GS}=0V,$ $F=1.0\text{MHz}$ | - | 6500 | - | PF |
| Output Capacitance | C_{oss} | | - | 290 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 220 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=30V, I_D=2A, R_L=15\Omega$ $V_{GS}=10V, R_G=2.5\Omega$ | - | 26 | - | nS |
| Turn-on Rise Time | t_r | | - | 24 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 91 | - | nS |
| Turn-Off Fall Time | t_f | | - | 39 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=30V, I_D=30A,$ $V_{GS}=10V$ | - | 163 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 31 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 64 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $V_{GS}=0V, I_S=40A$ | - | - | 1.2 | V |
| Diode Forward Current ^(Note 2) | I_S | | - | - | 40 | A |
| Reverse Recovery Time | t_{rr} | $T_J = 25^{\circ}\text{C}, I_F = 40A$ $di/dt = 100A/\mu s$ ^(Note 3) | - | 42 | - | nS |
| Reverse Recovery Charge | Q_{rr} | | - | 66 | - | nC |
| Forward Turn-On Time | t_{on} | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. E_{AS} condition: $T_J=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, L=1\text{mH}, R_G=25\Omega$

Test Circuit

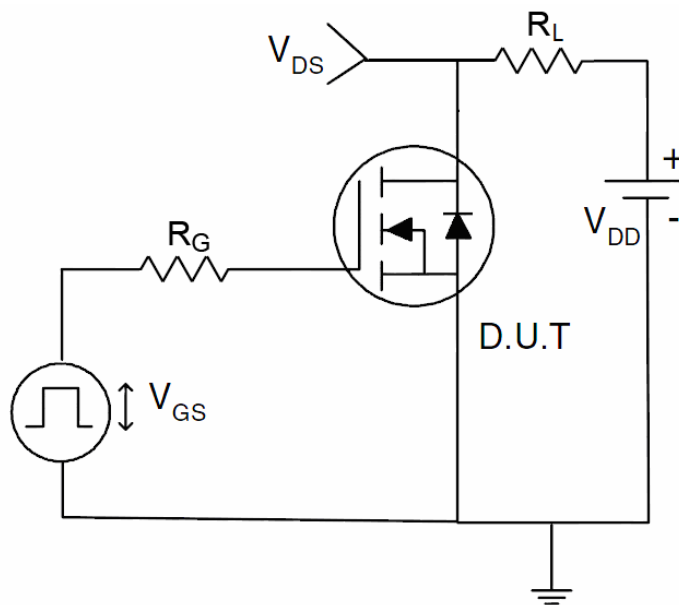
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

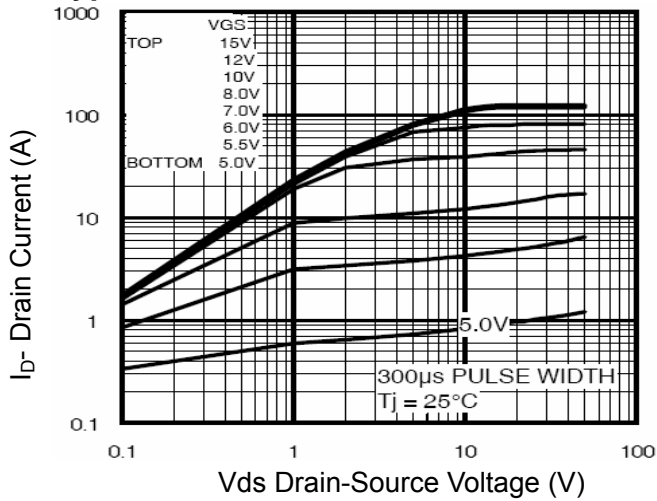


Figure 1 Output Characteristics

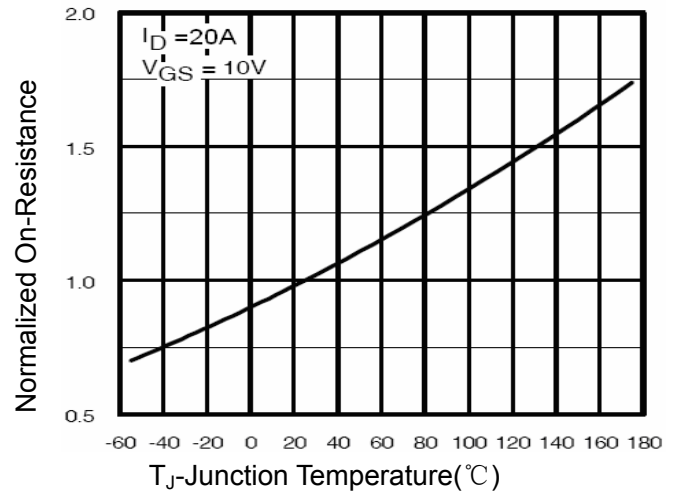


Figure 4 Rdson-Junction Temperature

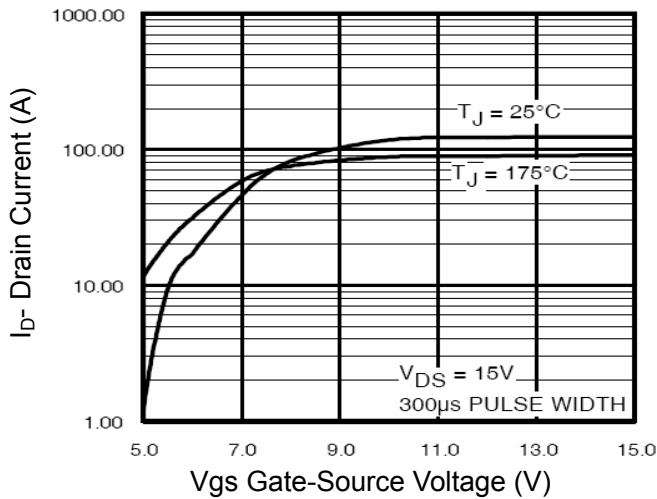


Figure 2 Transfer Characteristics

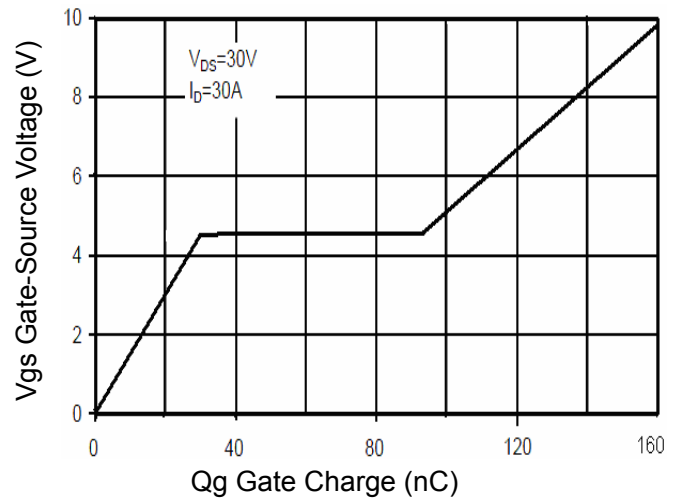


Figure 5 Gate Charge

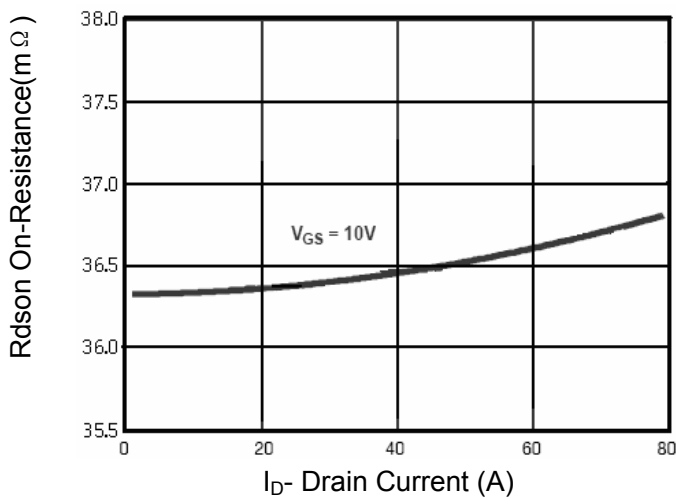


Figure 3 Rdson- Drain Current

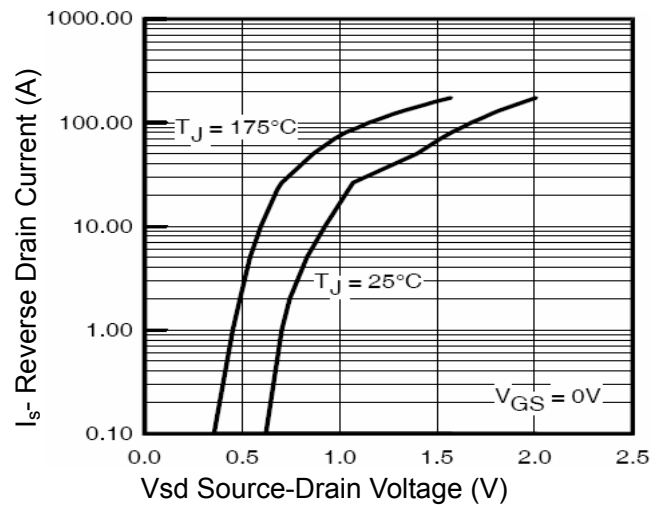


Figure 6 Source- Drain Diode Forward

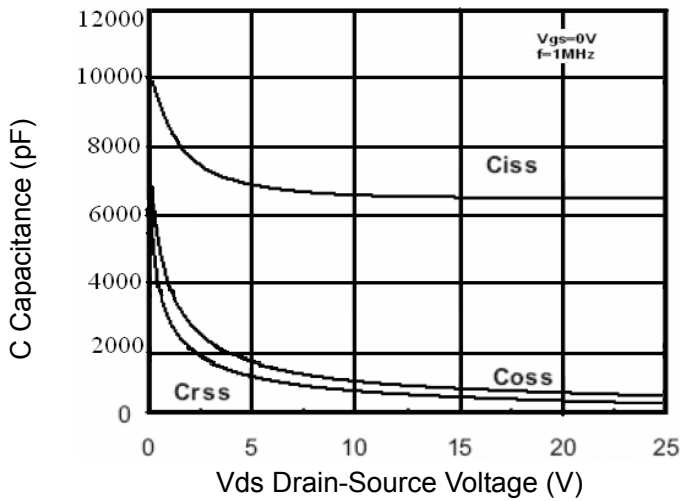


Figure 7 Capacitance vs Vds

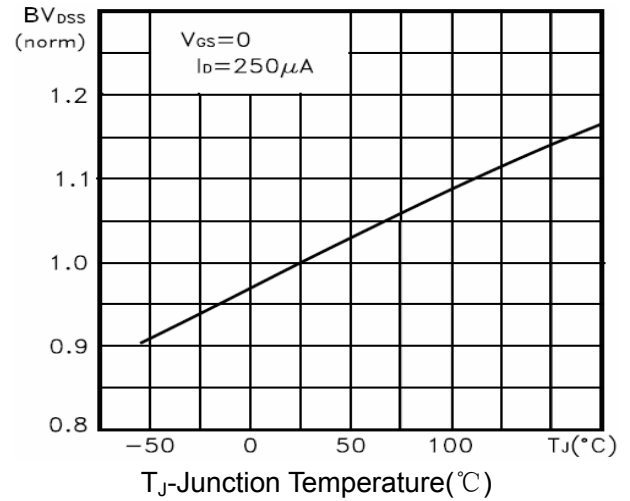


Figure 9 BV_{DSS} vs Junction Temperature

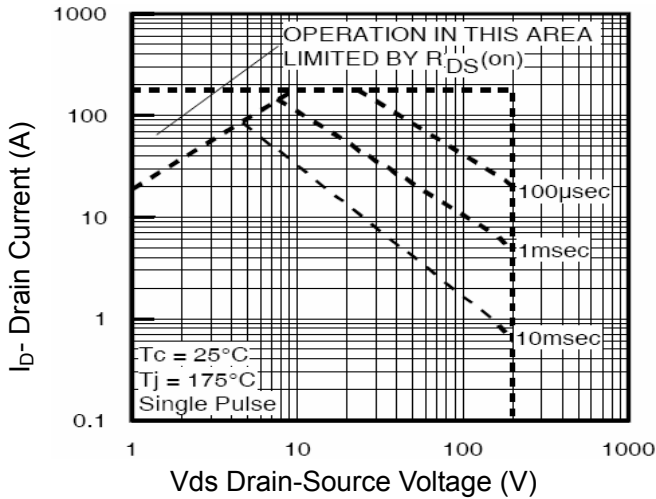


Figure 8 Safe Operation Area

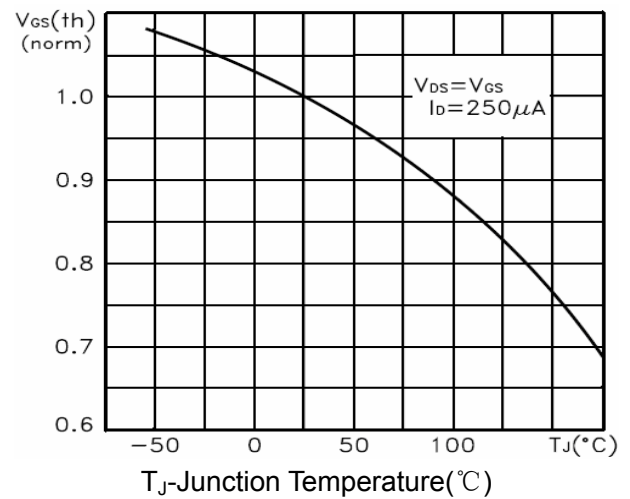


Figure 10 $V_{GS(th)}$ vs Junction Temperature

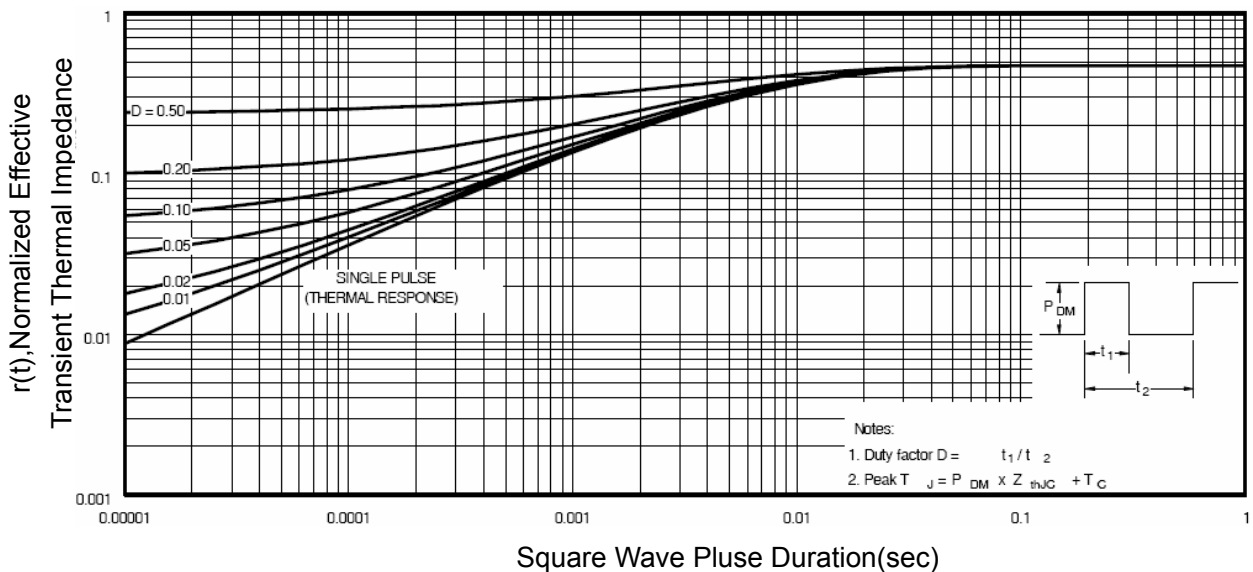
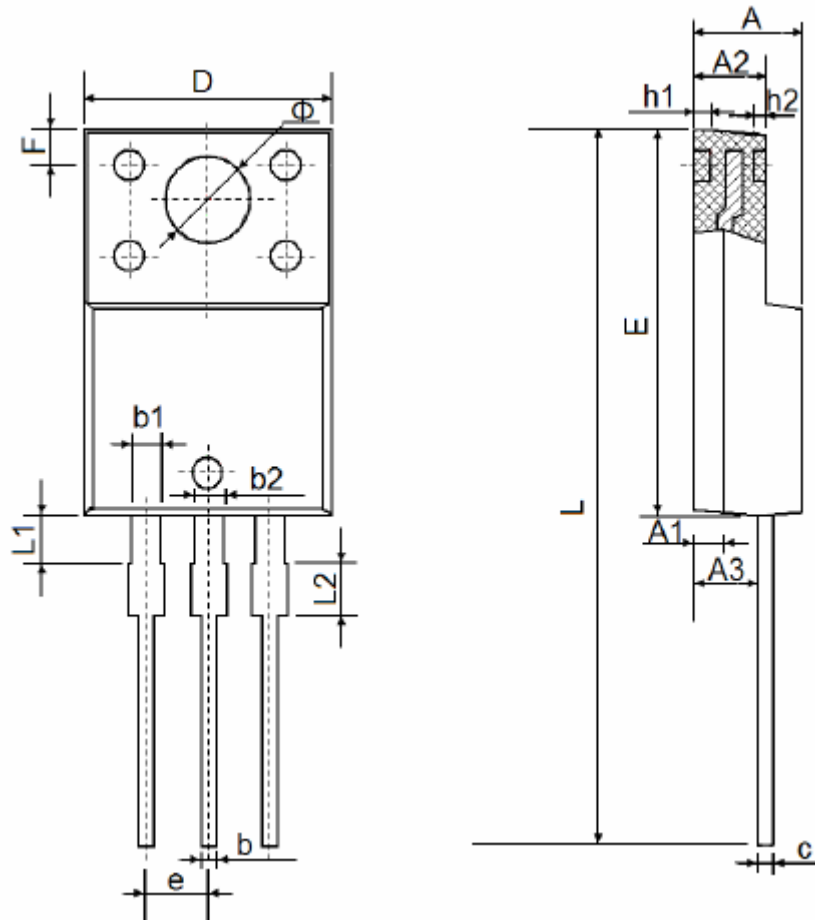


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220F Package Information


| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.300 | 4.700 | 0.169 | 0.185 |
| A1 | 1.300REF | | 0.051REF | |
| A2 | 2.800 | 3.200 | 0.110 | 0.126 |
| A3 | 2.500 | 2.900 | 0.098 | 0.114 |
| b | 0.500 | 0.750 | 0.020 | 0.030 |
| b1 | 1.100 | 1.350 | 0.043 | 0.053 |
| b2 | 1.500 | 1.750 | 0.059 | 0.069 |
| c | 0.500 | 0.750 | 0.020 | 0.030 |
| D | 9.960 | 10.360 | 0.392 | 0.408 |
| E | 14.800 | 15.200 | 0.583 | 0.598 |
| e | 2.540TYP. | | 0.100TYP | |
| F | 2.700REF | | 0.106REF | |
| Φ | 3.500REF | | 0.138REF | |
| h1 | 0.800REF | | 0.031REF | |
| h2 | 0.500REF | | 0.020REF | |
| L | 28.000 | 28.400 | 1.102 | 1.118 |
| L1 | 1.700 | 1.900 | 0.067 | 0.075 |
| L2 | 1.900 | 2.100 | 0.075 | 0.083 |

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